

# NP120N04NUK

40 V – 120 A – N-channel Power MOS FET Application: Automotive

R07DS1253EJ0100 Rev.1.00 Mar 30, 2015

## **Description**

The NP120N04NUK is N-channel MOS Field Effect Transistors designed for high current switching applications.

#### **Features**

- Super low on-state resistance  $R_{DS(on)} = 1.95 \ m\Omega \ MAX. \ (V_{GS} = 10 \ V, \ I_D = 60 \ A)$
- Low  $C_{iss}$ :  $C_{iss} = 8300 \text{ pF TYP.} (V_{DS} = 25 \text{ V})$
- Designed for automotive application and AEC-Q101 qualified

## **Ordering Information**

Part No.	Lead Plating	Packing	Package
NP120N04NUK-S18-AY *1	Pure Sn (Tin)	Tube 50 p/tube	TO-262 (MP-25SK)

Note: \*1 Pb-free (This product does not contain Pb in the external electrode)

## **Absolute Maximum Ratings (TA = 25°C)**

Item	Symbol	Ratings	Unit
Drain to Source Voltage (V <sub>GS</sub> = 0 V)	V <sub>DSS</sub>	40	V
Gate to Source Voltage (V <sub>DS</sub> = 0 V)	V <sub>GSS</sub>	±20	V
Drain Current (DC) (T <sub>C</sub> = 25°C)	I <sub>D(DC)</sub>	±120	Α
Drain Current (pulse) *1	I <sub>D(pulse)</sub>	±480	Α
Total Power Dissipation (T <sub>C</sub> = 25°C)	P <sub>T1</sub>	288	W
Total Power Dissipation (T <sub>A</sub> = 25°C)	P <sub>T2</sub>	1.8	W
Channel Temperature	T <sub>ch</sub>	175	°C
Storage Temperature	T <sub>stg</sub>	-55 to +175	°C
Repetitive Avalanche Current *2	I <sub>AR</sub>	66	А
Repetitive Avalanche Energy *2	E <sub>AR</sub>	435	mJ

Notes: \*1 Tc = 25°C,  $P_W \le 10~\mu s$ , Duty Cycle  $\le 1\%$ 

#### **Thermal Resistance**

<sup>\*2</sup> R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20 V  $\rightarrow$  0 V

# **Electrical Characteristics** (T<sub>A</sub> = 25°C)

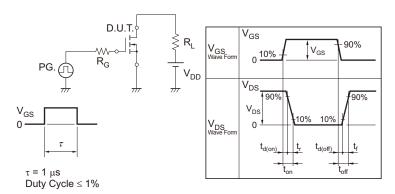
Item	Symbol	MIN.	TYP.	MAX.	Unit	Test Conditions	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$	
Gate Leakage Current	Igss	_	_	±100	nA	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	
Gate to Source Threshold Voltage	V <sub>GS(th)</sub>	2.0	3.0	4.0	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	
Forward Transfer Admittance *1	yfs	60	125	_	S	$V_{DS} = 5 \text{ V}, I_{D} = 60 \text{ A}$	
Drain to Source On-state Resistance *1	R <sub>DS(on)</sub>	_	1.65	1.95	mΩ	$V_{GS} = 10 \text{ V}, I_D = 60 \text{ A}$	
Input Capacitance	C <sub>iss</sub>	_	8300	12450	pF	V <sub>DS</sub> = 25 V	
Output Capacitance	Coss	_	1200	1800	pF	$V_{GS} = 0 V$	
Reverse Transfer Capacitance	C <sub>rss</sub>	_	440	800	pF	f = 1 MHz	
Turn-on Delay Time	t <sub>d(on)</sub>	_	30	70	ns	$V_{DD} = 20 \text{ V}, I_D = 60 \text{ A}$	
Rise Time	t <sub>r</sub>	_	11	30	ns	V <sub>GS</sub> = 10 V	
Turn-off Delay Time	t <sub>d(off)</sub>	_	115	230	ns	$R_G = 0 \Omega$	
Fall Time	t <sub>f</sub>	_	13	40	ns		
Total Gate Charge	$Q_{G}$	_	160	240	nC	$V_{DD} = 32 \text{ V}$	
Gate to Source Charge	$Q_{GS}$	_	42	_	nC	$V_{GS} = 10 \text{ V}$	
Gate to Drain Charge	$Q_{GD}$	_	42	_	nC	I <sub>D</sub> = 120 A	
Body Diode Forward Voltage *1	$V_{F(S-D)}$		0.9	1.5	V	I <sub>F</sub> = 120 A, V <sub>GS</sub> = 0 V	
Reverse Recovery Time	t <sub>rr</sub>		61		ns	I <sub>F</sub> = 120 A, V <sub>GS</sub> = 0 V	
Reverse Recovery Charge	Q <sub>rr</sub>	_	100	_	nC	di/dt = 100 A/μs	

Note: \*1 Pulsed test

#### **TEST CIRCUIT 1 AVALANCHE CAPABILITY**

# $V_{GS} = 20 \rightarrow 0 \text{ V}$ $V_{DD}$ $V_{DD}$

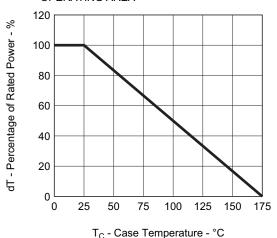
#### **TEST CIRCUIT 2 SWITCHING TIME**



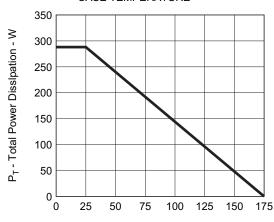
#### **TEST CIRCUIT 3 GATE CHARGE**

## **Typical Characteristics** $(T_A = 25^{\circ}C)$

# DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA

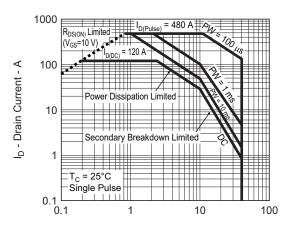


# TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



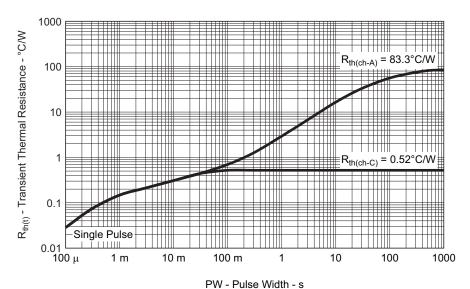
T<sub>C</sub> - Case Temperature - °C

#### FORWARD BIAS SAFE OPERATING AREA



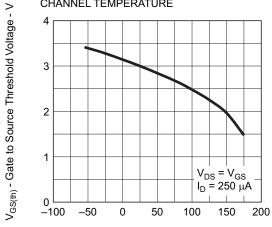
 $V_{\rm DS}$  - Drain to Source Voltage - V

## TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



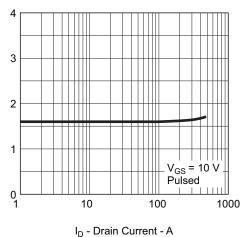
#### DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE 600 500 I<sub>D</sub> - Drain Current - A 400 300 200 100 $V_{GS}$ = 10 VPulsed 0 0.2 0.4 0.6 1.0 0 8.0 V<sub>DS</sub> - Drain to Source Voltage - V



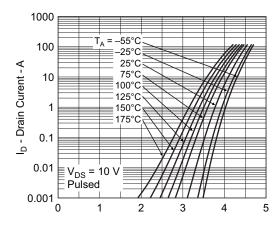


DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

T<sub>ch</sub> - Channel Temperature - °C

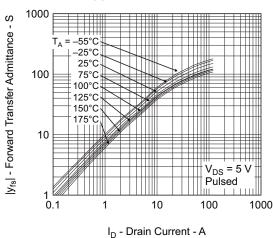


#### FORWARD TRANSFER CHARACTERISTICS

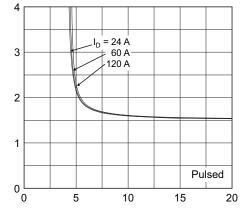


V<sub>GS</sub> - Gate to Source Voltage - V

# FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



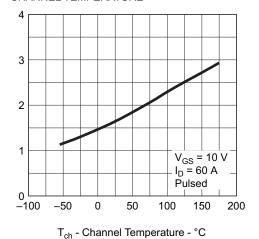
V<sub>GS</sub> - Gate to Source Voltage - V

 $R_{DS(on)}$  - Drain to Source On-State Resistance -  $m\Omega$ 

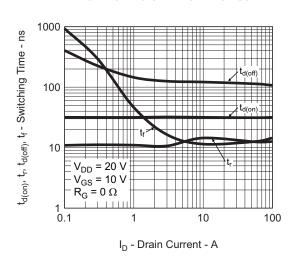
 $R_{DS(on)}$  - Drain to Source On-State Resistance -  $m\Omega$ 

 $R_{\text{DS(on)}}$  - Drain to Source On-State Resistance -  $m\Omega$ 

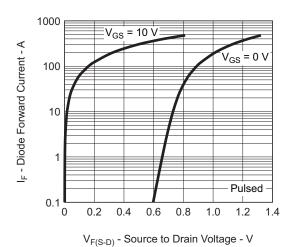
# DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



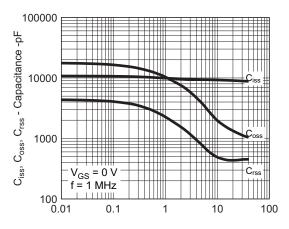
# SWITCHING CHARACTERISTICS



#### SOURCE TO DRAIN DIODE FORWARD VOLTAGE

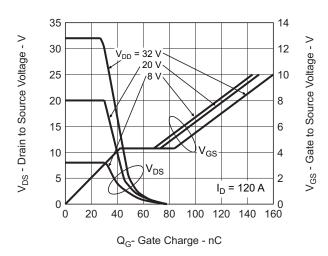


#### CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE

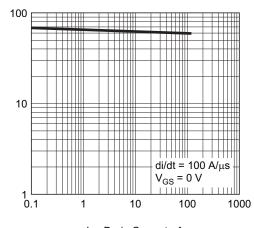


 $V_{DS}$  - Drain to Source Voltage - V

#### DYNAMIC INPUT/OUTPUT CHARACTERISTICS



REVERSE RECOVERY TIME vs. DRAIN CURRENT

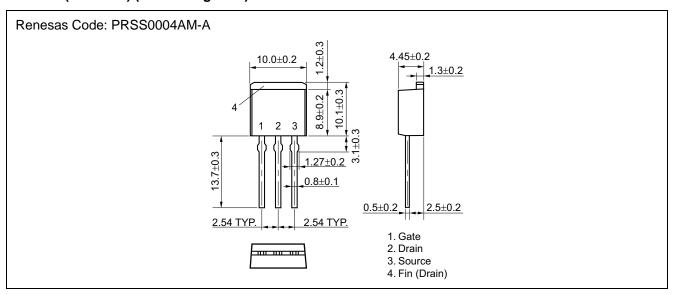


I<sub>F</sub> - Drain Current - A

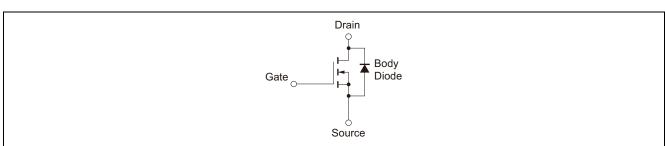
t<sub>rr</sub> - Reverse Recovery Time - ns

# Package Drawing (Unit: mm)

### TO-262 (MP-25SK) (Mass: 1.8 g TYP.)



# **Equivalent Circuit**



Remark: Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

**Revision History** 

# NP120N04NUK Data Sheet

		Description		
Rev.	Date	Page	Summary	
1.00	Mar 30, 2015	_	First Edition Issued	

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Renesas Electronics America Inc. 2801 Scott Boulevard Santa Clara, CA 95050-2549, U.S.A. Tel: +1-408-588-6000, Fax: +1-408-588-6130

Renesas Electronics Canada Limited 9251 Yonge Street, Suite 8309 Richmond Hill, Ontario Canada L4C 9T3 Tel: +1-905-237-2004

Renesas Electronics Europe Limited Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K Tel: +44-1628-585-100, Fax: +44-1628-585-900

Renesas Electronics Europe GmbH

Arcadiastrasse 10, 40472 Düsseldorf, Germany Tel: +49-211-6503-0, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd.
Room 1709, Quantum Plaza, No.27 ZhiChunLu Haidian District, Beijing 100191, P.R.China Tel: +86-10-8235-7679

Renesas Electronics (Shanghai) Co., Ltd.
Unit 301, Tower A, Central Towers, 555 Langao Road, Putuo District, Shanghai, P. R. China 200333
Tel: 486-21-2226-0888, Fax: +86-21-2226-0999

Renesas Electronics Hong Kong Limited
Unit 1601-1611, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong
Tel: +852-2865-6688, Fax: +852 2886-9022

Renesas Electronics Taiwan Co., Ltd. 13F, No. 363, Fu Shing North Road, Taipei 10543, Taiwan Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

Renesas Electronics Singapore Pte. Ltd. 80 Bendemeer Road, Unit #06-02 Hyflux Innovation Centre, Singapore 339949 TEI: +65-6213-0200, Fax: +65-6213-0300

Renesas Electronics Malaysia Sdn.Bhd.
Unit 1207, Block B, Menara Amcorp, Amcorp Trade Centre, No. 18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tei: +60-3-7955-9390, Fax: +60-3-7955-9510

Renesas Electronics India Pvt. Ltd.
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